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Prior Application: J. TANAKA et al
Serial No. 10/179,214
Filed: June 26, 2002

Group Art Unit: 2815
Examiner: S. Clark
For: RESIN-ENCAPSULATED SEMICONDUCTOR
APPARATUS AND PROCESS FOR ITS
FABRICATION

Commissioner of Patents
Box: Patent Application
Washington, D.C. 20231

This is a request for filing a continuation application under 37 C.F.R. 1.53(b) of pending prior application Serial No. 10/179,214, filed on June 26, 2002, entitled RESIN-ENCAPSULATED SEMICONDUCTOR APPARATUS AND PROCESS FOR ITS FABRICATION, by all of the inventors named in the prior application.

- CLAIMS AS FILED IN THE PRIOR APPLICATION
LESS ANY CLAIMS CANCELED BY AMENDMENT BELOW
PLUS ANY CLAIMS ADDED BY ACCOMPANYING PRELIMINARY AMENDMENT

Basic Fee							\$ 750.00
Total Claims	05	-	20	=	0	x 18	= \$ 0.00
Independent Claims	01	-	3	=	0	x 84	= \$ 0.00
Total Filing Fee							\$ 750.00

3. A Credit Card Payment Form including the amount of \$750.00 is enclosed to cover the Filing Fee.

4. Cancel claims 1-13 before calculating the Filing Fee. A Preliminary Amendment is being filed herewith.

5. The Commissioner is hereby authorized to charge any additional fees which may be required, or to credit any overpayment, to Deposit Account No. 50-1417. A duplicate copy of this Request is enclosed for this purpose.

6. Amend the specification by inserting, before the first line:

This is a continuation application of U.S. Serial No. 10/179,214, filed on June 26, 2002, which is a continuation application of U.S. Serial No. 09/969,847, filed October 4, 2001, now U.S. Patent No. 6,465,827, which is a continuation application of U.S. Serial No. 09/689,802, filed October 13, 2000, now U.S. Patent No. 6,441,416, which is a continuation application of U.S. Serial No. 09/665,062, filed September 19, 2000, abandoned, which is a divisional application of U.S. Serial No. 09/012,104, filed January 22, 1998, now U.S. Patent No. 6,147,374. This application is related to application Serial No. 09/969,848, filed October 4, 2001, now U.S. Patent No. 6,525,359.

7. New drawings are enclosed, three (3) sheets, Figs. 1-4.

8. The power of attorney is set forth in the Declaration in the prior application or an associate power of attorney is hereby granted to:

Jeffrey M. Ketchum, Registration No. 31,174
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There is a change in the correspondence address.

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Please associate this application with Customer No. 24956.


9. The prior application is assigned to Hitachi, Ltd.

10. Priority of the following Japanese patent applications is claimed under 35 U.S.C. § 119:

No. 9-009276, filed January 22, 1997.

The certified priority document has been filed in the parent application Ser. No. 09/012,104.

The undersigned hereby declares that no matter contained in the specification, including the claims, and drawings filed in the present continuation application would have been new matter in the prior application Serial No. 10/179,214, as originally filed on June 26, 2002.


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Date: September 29, 2003